


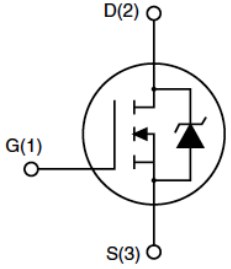


Description

<p>Features</p> <ul style="list-style-type: none"> ● 650V,20A ● $R_{DS(ON)} = 0.35\Omega$ (Typ.) @ $V_{GS} = 10V, I_D = 10A$ ● Fast Switching ● Improved dv/dt Capability ● 100% Avalanche Tested 	<p>Application</p> <ul style="list-style-type: none"> ● Switch Mode Power Supply(SMPS) ● Uninterruptible Power Supply(UPS) ● Power Factor Correction (PFC) 		
 <p>TO-220F</p>	 <p>TO-247</p>	 <p>TO-3P</p>	 <p>Schematic Diagram</p>

Absolute Maximum Ratings (T_C=25°C unless otherwise specified)

Symbol	Parameter	Max.		Units	
		TO-220F	TO-247/TO-3P		
V _{DSS}	Drain-Source Voltage	650		V	
V _{GSS}	Gate-Source Voltage	±30		V	
I _D	Continuous Drain Current	T _C = 25°C	20	A	
		T _C = 100°C	13	A	
I _{DM}	Pulsed Drain Current ^{note1}	80		A	
E _{AS}	Single Pulsed Avalanche Energy ^{note2}	1350		mJ	
P _D	Power Dissipation	T _C = 25°C	167	416	W
R _{θJC}	Thermal Resistance, Junction to Case	0.75	0.3	°C/W	
R _{θJA}	Thermal Resistance, Junction to Ambient	60	60	°C/W	
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150		°C	

Electrical Characteristics ($T_C=25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
Off Characteristic						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	650	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650V, V_{GS} = 0V,$ $T_J = 25^{\circ}\text{C}$	-	-	1	μA
I_{GSS}	Gate to Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 30V$	-	-	± 100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	2	3	4	V
$R_{DS(on)}$ <small>note3</small>	Static Drain-Source on-Resistance	$V_{GS} = 10V, I_D = 10A$	-	0.35	0.45	Ω
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$ $f = 1.0\text{MHz}$	-	2978	-	pF
C_{oss}	Output Capacitance		-	291	-	pF
C_{riss}	Reverse Transfer Capacitance		-	40	-	pF
Q_g	Total Gate Charge	$V_{DD} = 520V, I_D = 20A,$ $V_{GS} = 10V$	-	80	-	nC
Q_{gs}	Gate-Source Charge		-	12	-	nC
Q_{gd}	Gate-Drain("Miller") Charge		-	34	-	nC
Switching Characteristics						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD} = 325V, I_D = 20A,$ $R_G = 25\Omega$	-	37	-	ns
t_r	Turn-on Rise Time		-	66	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	175	-	ns
t_f	Turn-off Fall Time		-	84	-	ns
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain to Source Diode Forward Current		-	-	20	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	80	A
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{SD} = 20A$	-	-	1.4	V
t_{rr}	Reverse Recovery Time	$V_{GS} = 0V, I_S = 20A,$ $di/dt = 100A/\mu s$	-	450	-	ns
Q_{rr}	Reverse Recovery Charge		-	7.1	-	μC

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

 2. $I_{AS} = 16A, V_{DD} = 50V, R_G = 25\Omega, \text{Starting } T_J = 25^{\circ}\text{C}$

 3. Pulse Test: Pulse Width $\leq 350\mu s$, Duty Cycle $\leq 1\%$

Typical Performance Characteristics

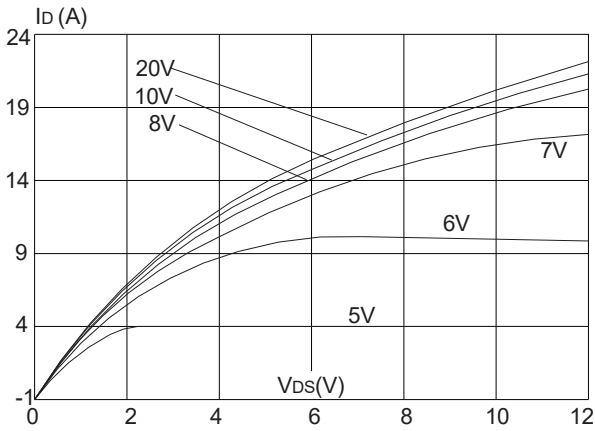
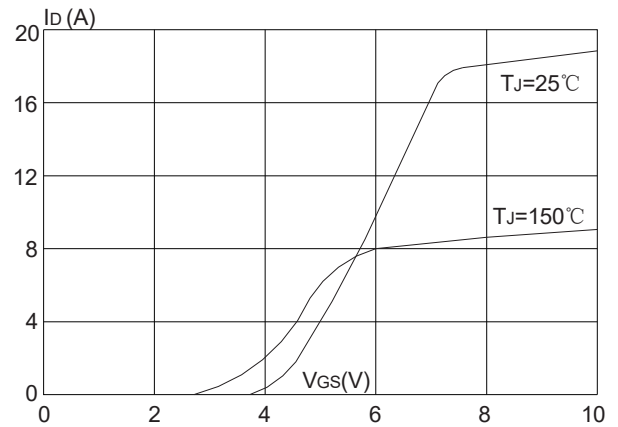
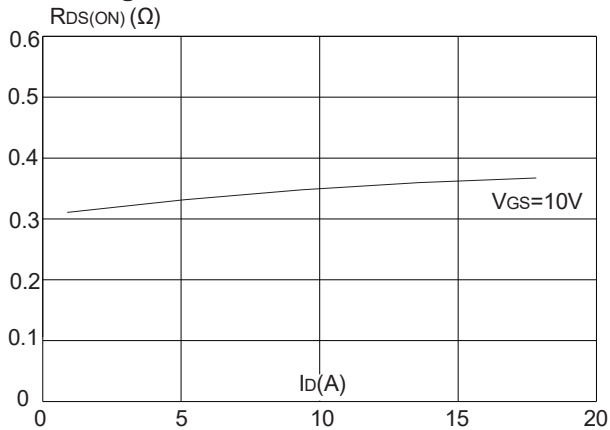
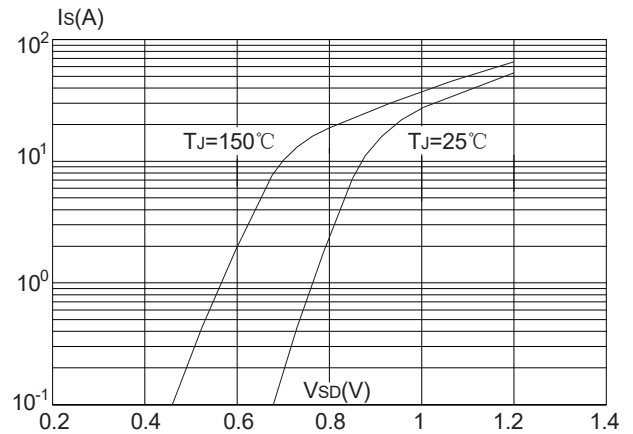
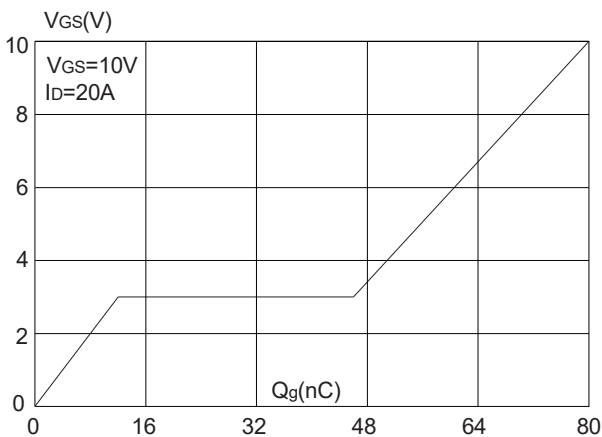
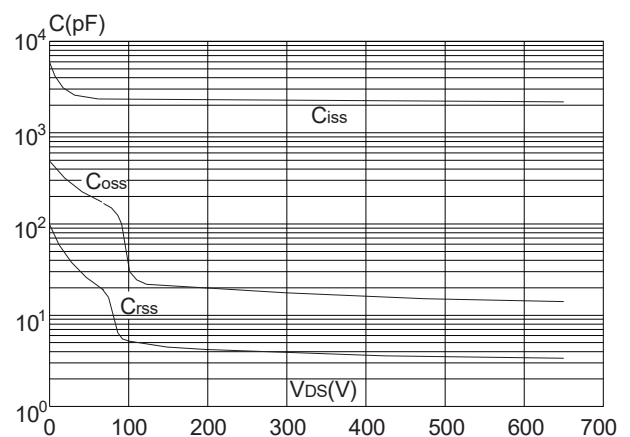
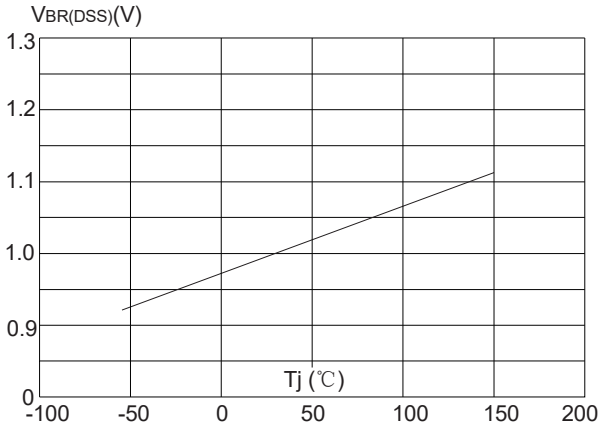
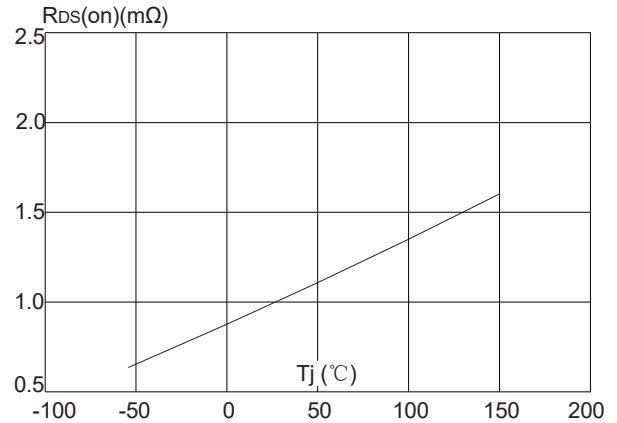
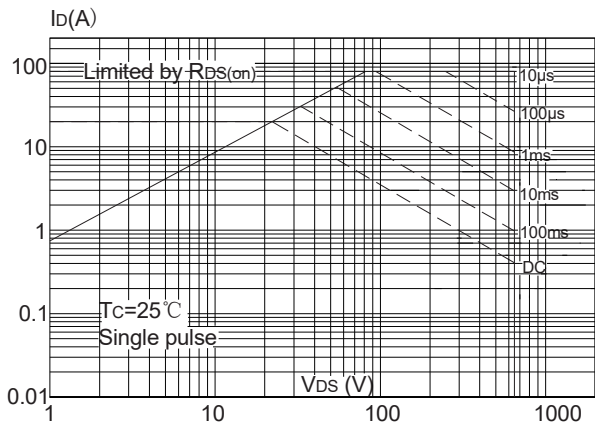
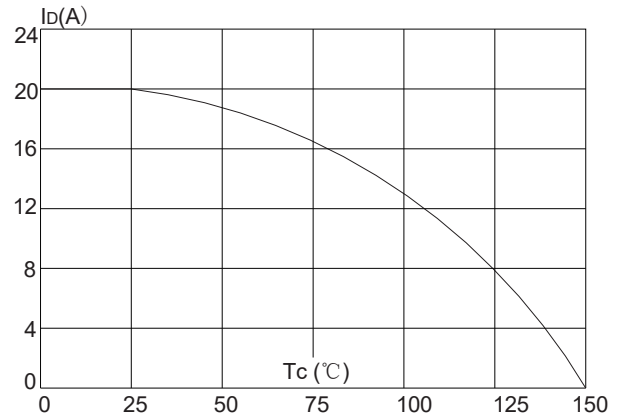
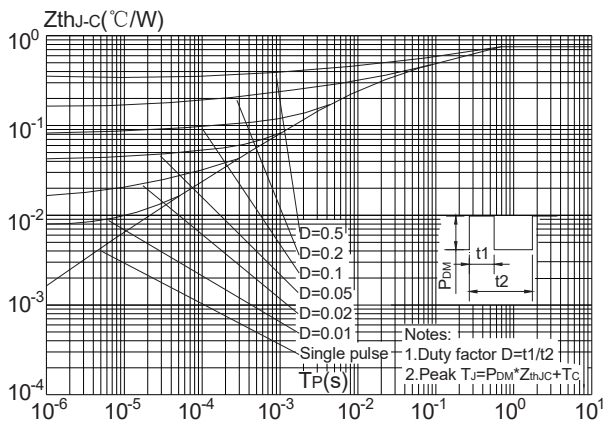
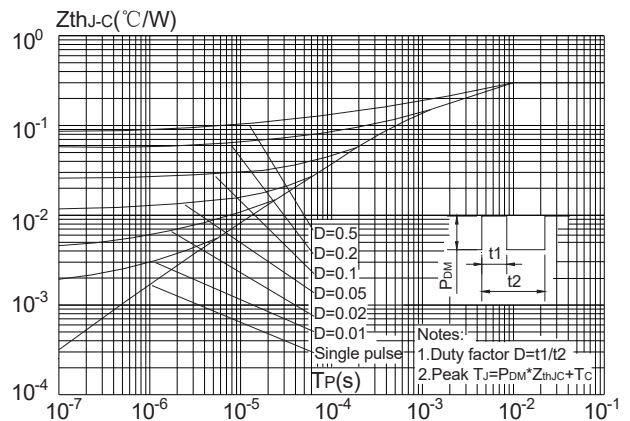
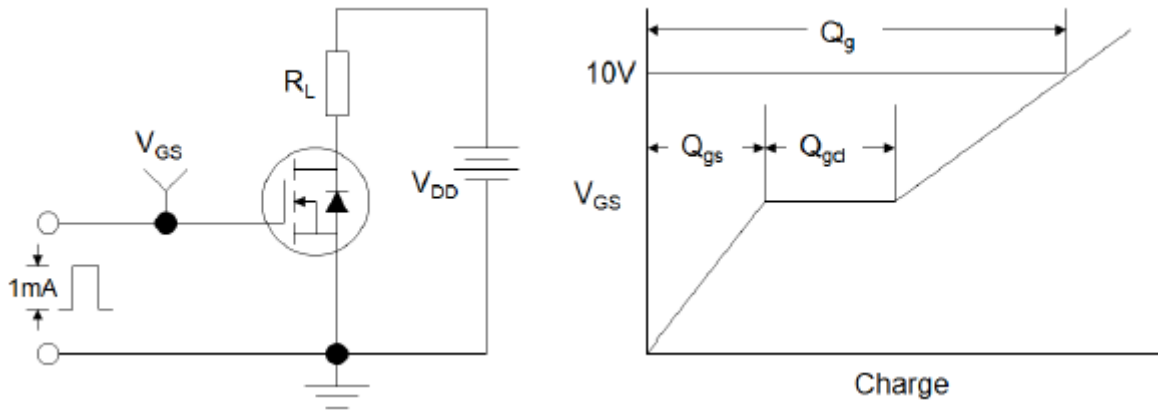
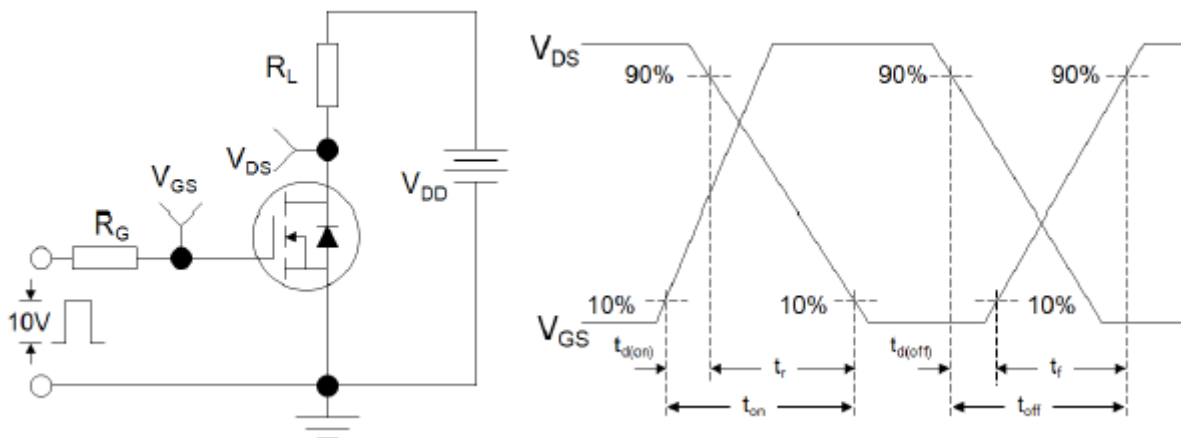
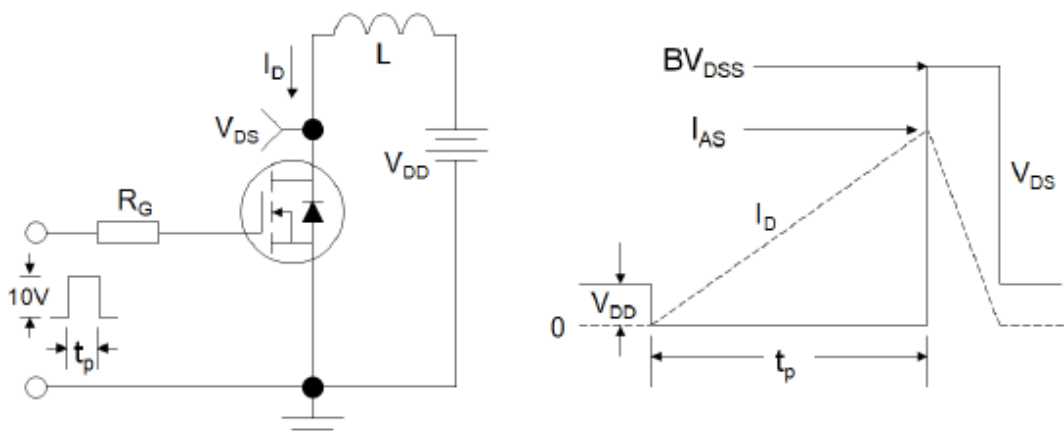
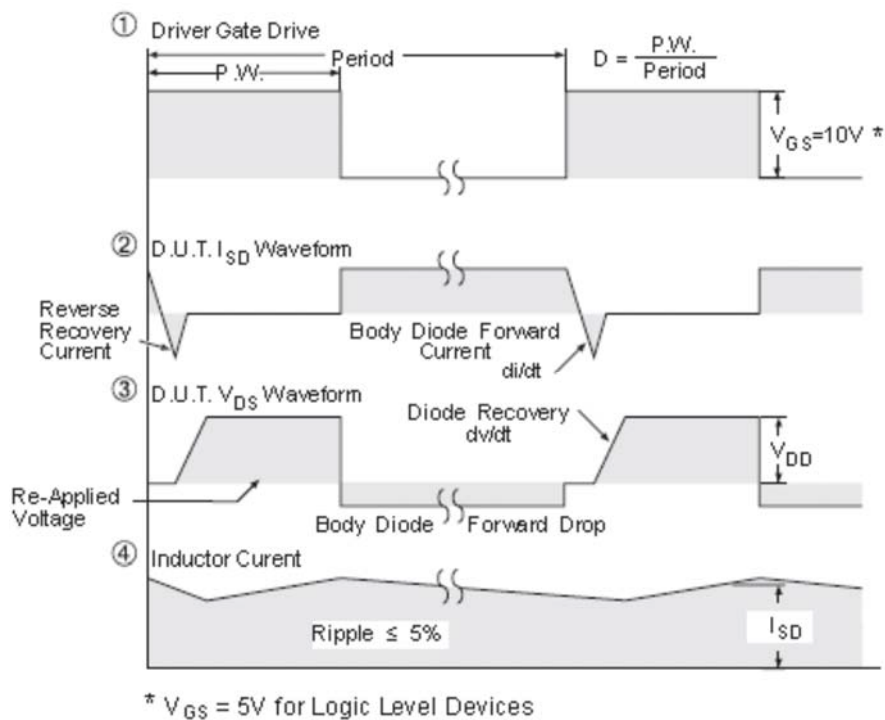
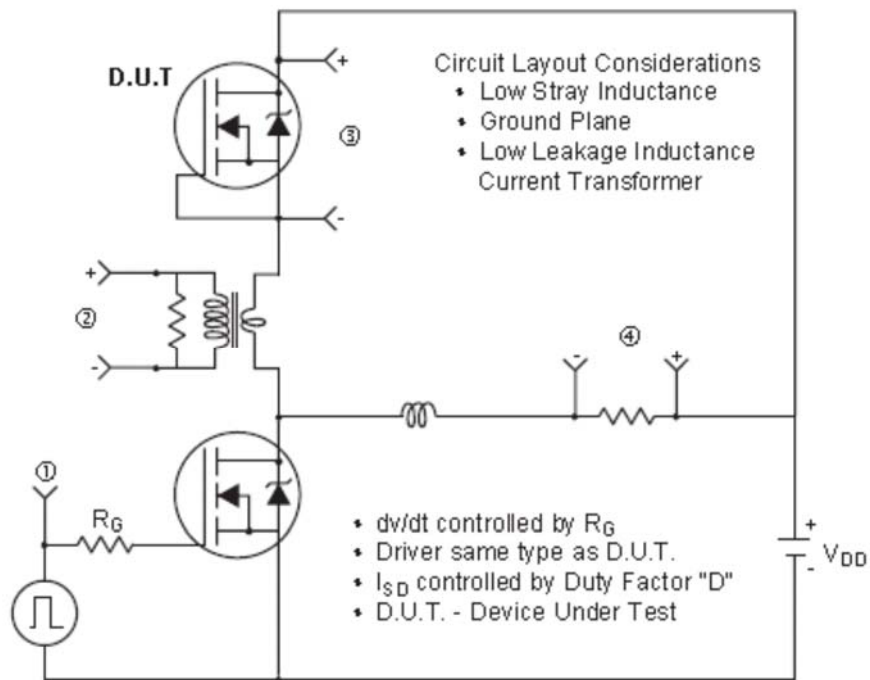
Figure 1: Output Characteristics

Figure 2: Typical Transfer Characteristics

Figure 3: On-resistance vs. Drain Current

Figure 4: Body Diode Characteristics

Figure 5: Gate Charge Characteristics

Figure 6: Capacitance Characteristics


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

Figure 8: Normalized on Resistance vs. Junction Temperature

Figure 9: Maximum Safe Operating Area

Figure 10: Maximum Continuous Drain Current vs. Case Temperature

Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case (TO-220F)

Figure.12: Maximum Effective Transient Thermal Impedance, Junction-to-Case (TO-247, TO-3P)



Figure1:Gate Charge Test Circuit & Waveform

Figure 2: Resistive Switching Test Circuit & Waveforms

Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms


Figure 4: Peak Diode Recovery dv/dt Test Circuit & Waveforms (For N-channel)